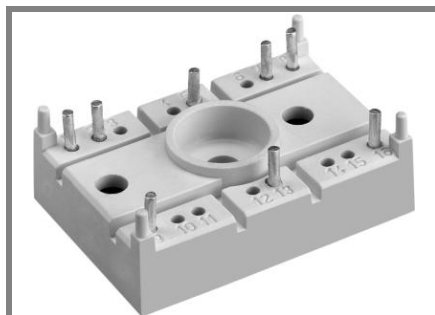


# SK 50 GARL 065 F



**SEMITOP® 2**

## IGBT Module

### SK 50 GARL 065 F

Preliminary Data

#### Features

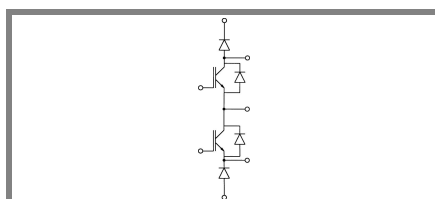
- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- N-channel homogeneous silicon structure (NPT-Non punch-through IGBT)
- Low tail current with low temperature dependence
- Low threshold voltage
- Fast Turbo diode

#### Typical Applications

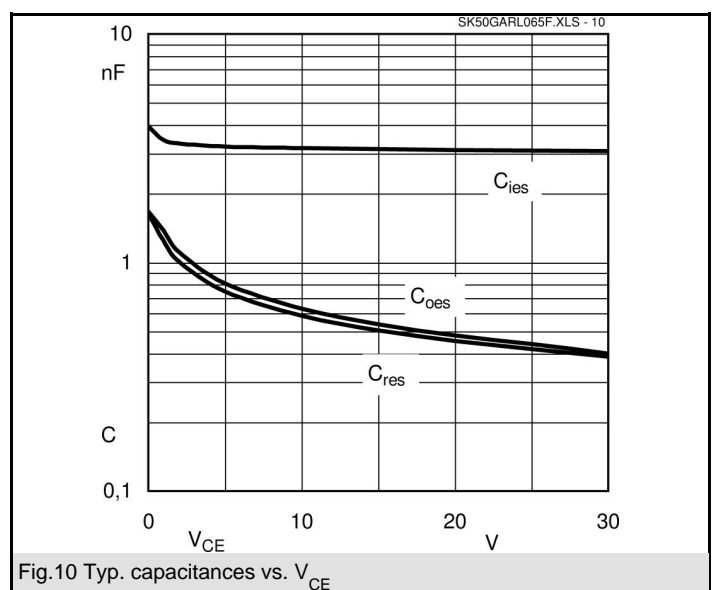
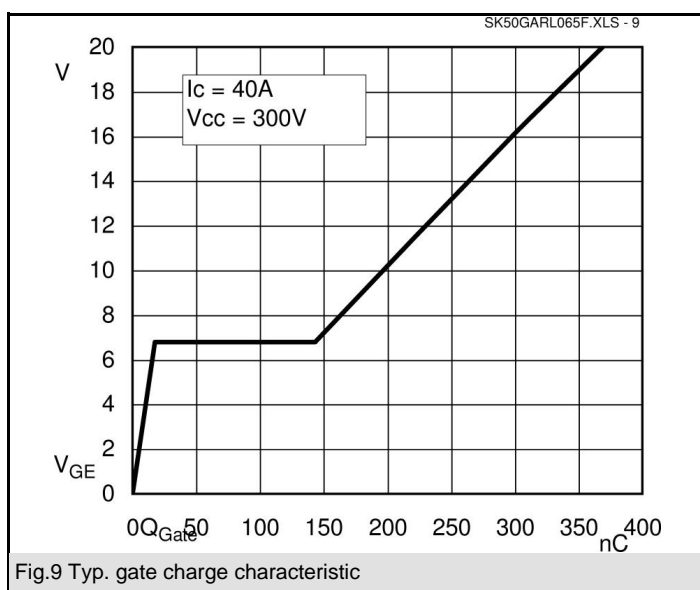
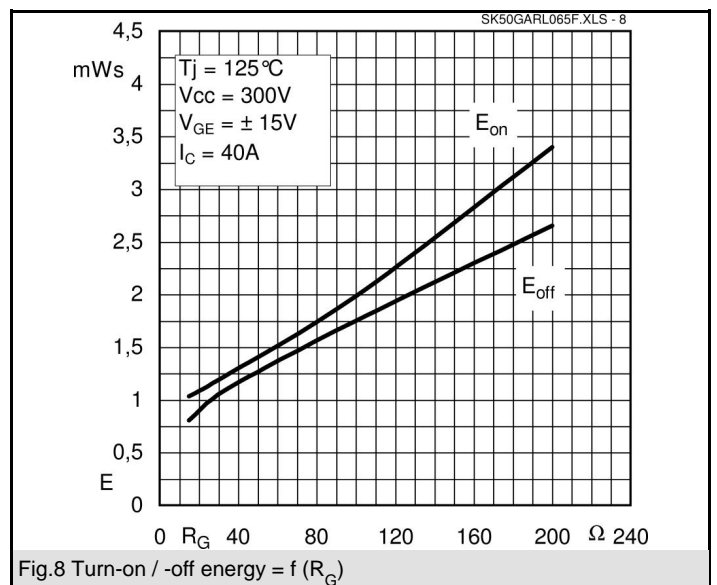
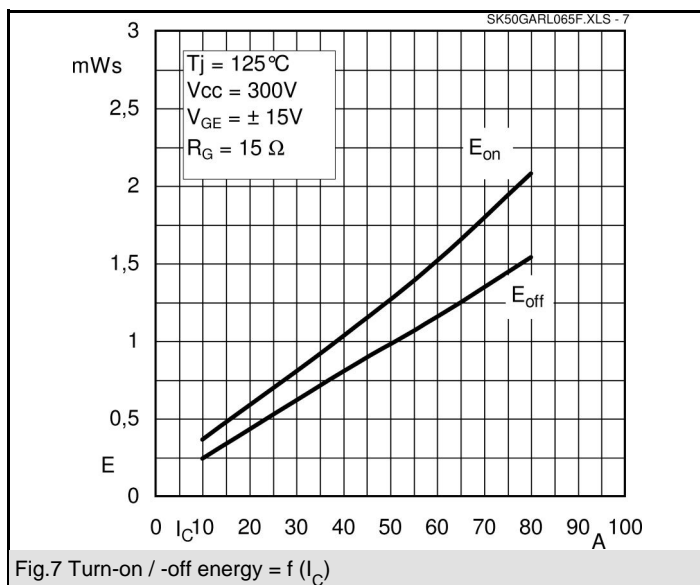
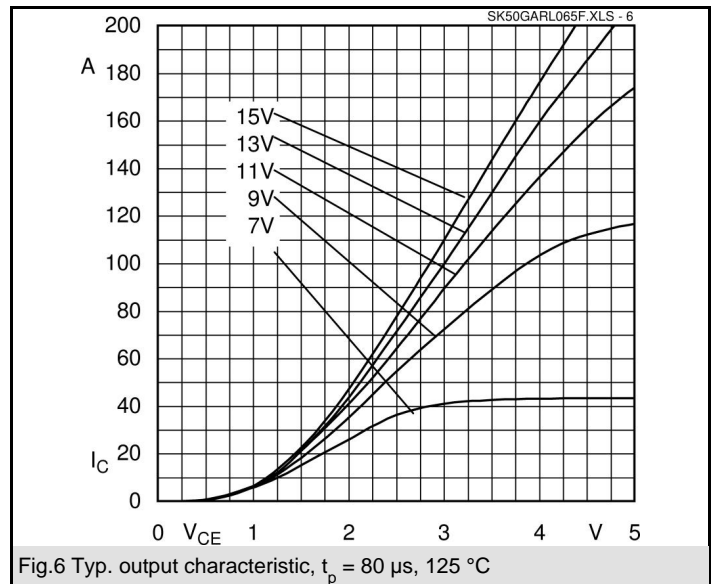
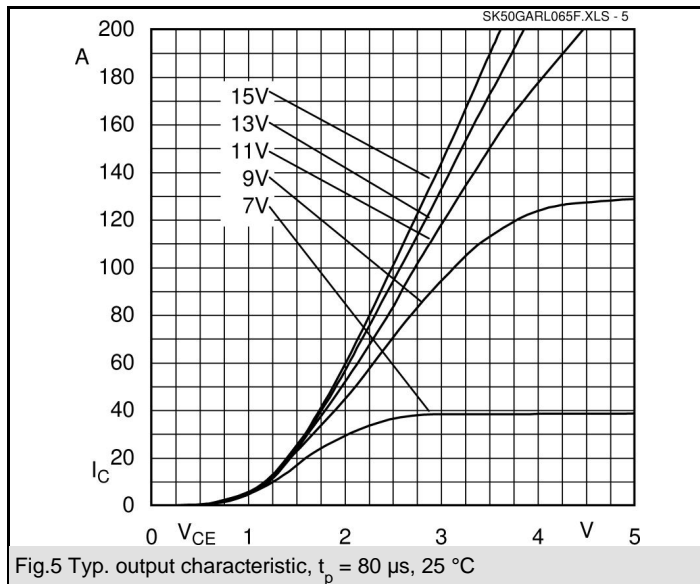
- Switching (not for linear use)
- Inverter
- Switched mode power supplies
- UPS

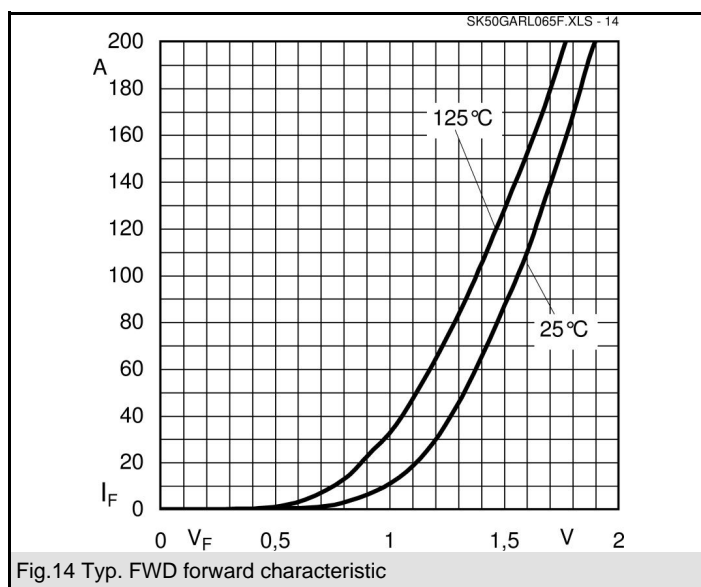
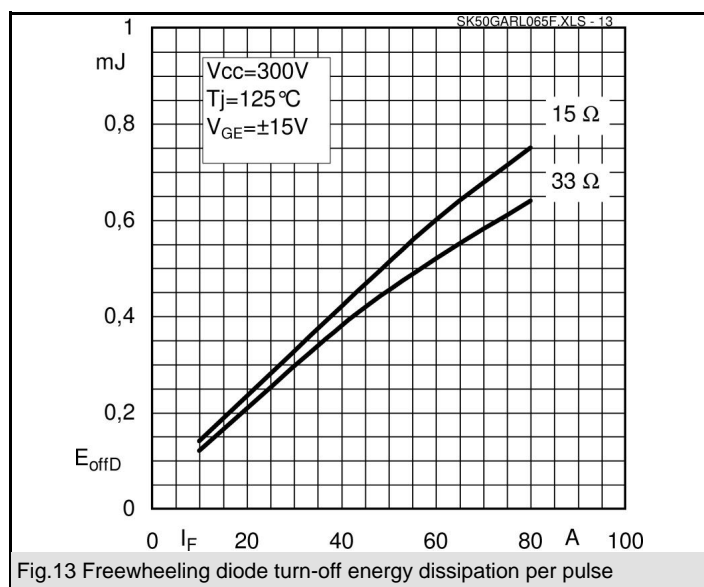
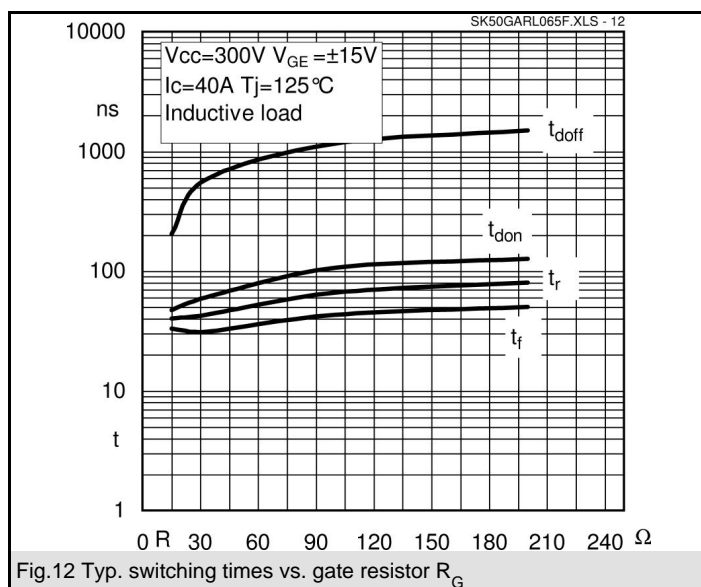
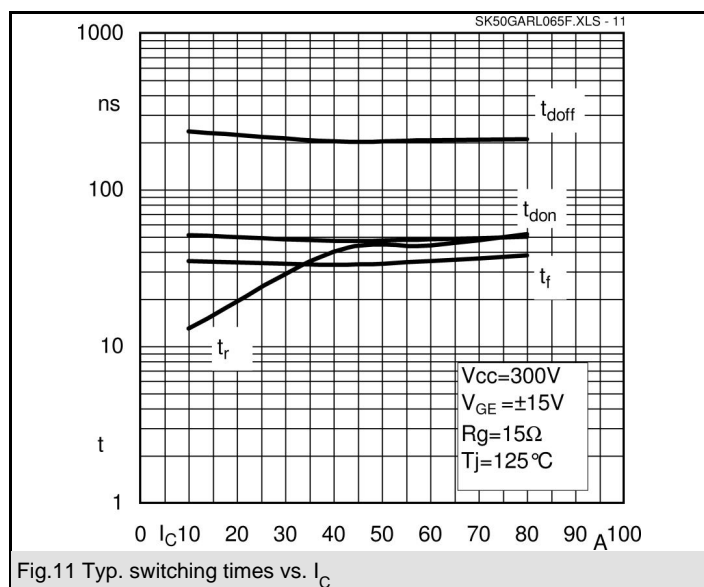
Absolute Maximum Ratings		$T_s = 25\text{ °C}$ , unless otherwise specified	
Symbol	Conditions	Values	Units
<b>IGBT</b>			
$V_{CES}$		600	V
$V_{GES}$		$\pm 20$	V
$I_C$	$T_s = 25\text{ (80) °C}$ ;	54 (40)	A
$I_{CM}$	$t_p < 1\text{ ms}$ ; $T_s = 25\text{ (80) °C}$ ;	108 (80)	A
$T_j$		- 40 ... + 150	°C
<b>Freewheeling diode</b>			
$I_F$	$T_s = 25\text{ (80) °C}$ ;	82 (50)	A
$I_{FM} = -I_{CM}$	$t_p < 1\text{ ms}$ ; $T_s = 25\text{ (80) °C}$ ;	160 (100)	A
$T_j$		- 40 ... + 150	°C
$T_{stg}$		- 40 ... + 125	°C
$T_{sol}$	Terminals, 10 s	260	°C
$V_{isol}$	AC 50 Hz, r.m.s. 1 min. / 1 s	2500 / 3000	V

Characteristics		$T_s = 25\text{ °C}$ , unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
<b>IGBT</b>					
$V_{CE(sat)}$	$I_C = 40\text{ A}$ , $T_j = 25\text{ (125) °C}$		1,7 (2,2)	2 (2,2)	V
$V_{GE(th)}$	$V_{CE} = V_{GE}$ ; $I_C = 0,0007\text{ A}$	3	4	5	V
$C_{res}$	$V_{CE} = 25\text{ V}$ ; $V_{GE} = 0\text{ V}$ ; 1 MHz		3		nF
$R_{th(j-s)}$	per IGBT per module			0,85	K/W K/W
$t_{d(on)}$	under following conditions: $V_{CC} = 300\text{ V}$ , $V_{GE} = \pm 15\text{ V}$		47		ns
$t_r$	$I_C = 40\text{ A}$ , $T_j = 125\text{ °C}$		40		ns
$t_{d(off)}$	$R_{Gon} = R_{Goff} = 15\text{ }\Omega$		203		ns
$t_f$			33		ns
$E_{on} + E_{off}$	Inductive load		1,84		mJ
<b>Freewheeling diode</b>					
$V_F = V_{EC}$	$I_F = 60\text{ A}$ ; $T_j = 25\text{ (150) °C}$		1,1	1,6 (1,25)	V
$V_{(TO)}$	$T_j = (150)\text{ °C}$		(0,85)		V
$r_T$	$T_j = (150)\text{ °C}$		(7)		mΩ
$R_{th(j-s)}$				1,1	K/W
$I_{RRM}$	under following conditions: $I_F = 50\text{ A}$ ; $V_R = 300\text{ V}$		38		A
$Q_{rr}$	$di_F/dt = -1000\text{ A/}\mu\text{s}$		2		μC
$E_{off}$	$V_{GE} = 0\text{ V}$ ; $T_j = 125\text{ °C}$		0,45		mJ
<b>Mechanical data</b>					
M1	mounting torque	1,8		2	Nm
w			19		g
Case	SEMITOP® 2		T 31		



**GARL**

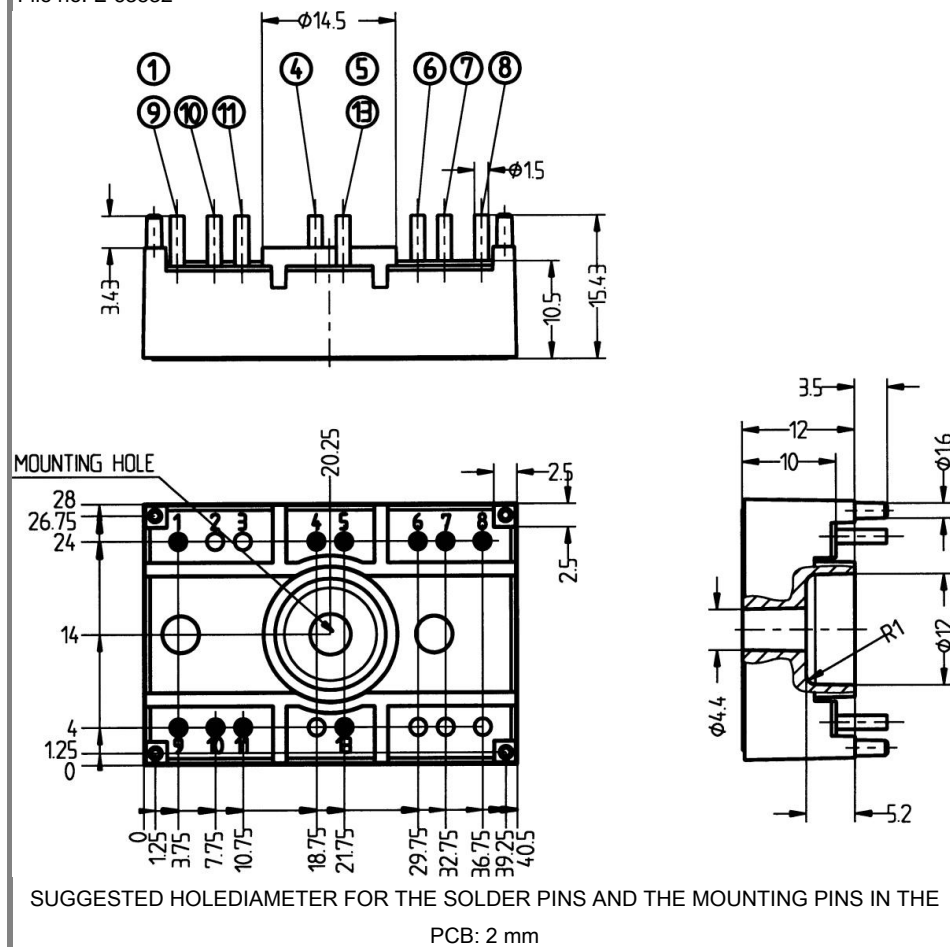




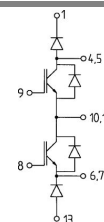
# SK 50 GARL 065 F

UL Recognized  
File no. E 63532

Dimensions in mm



Case T31



Case T31

GARL

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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